**Docket No.:** JG-SU-5224/500577.20013

Page 1

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As a be	elow named inventor(s),	I (we) hereby declare that:				
My (ou name(s	r) residence(s), post off	ce address(es) and citizenship(	s) is (are) the same as sta	ated below next to n	ny (our)	
I (we) believe I am (we are) an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:  MANUFACTURING METHOD OF SEMICONDUCTOR WAFER AND SEMICONDUCTOR WAFER MANUFACTURED BY THIS METHOD						
the spe	cification of which is at	ached hereto unless the following	an hox is chacked:			
[]	le specification of which is attached hereto unless the following box is checked:    was filed on as United States Application Number or					
	PCT International Application Number					
	and was amended on	(if ap	olicable).			
I (we) hereby state that I (we) have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I (we) acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.						
Things were substituted						
applica	non(s) for patent of inve	ority benefits under Title 35, Unitentor's certificate listed below and aving a filing date before that c	nd have also identified hal	love once forming -	lication for	
<i></i>		Prior Foreign Application(s):			-	
(Number)		(Country)	(Day/Month/Year)	Priority Claimed: YES NO		
2004–110634		Japan	05/04/2004	X		
· <del>,-,</del> .			79.00			
<del> </del>						
l (we) hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below:						
(Application Number) (Filing Date)						
I (we) hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I (we) acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulation, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.						
(Application Serial No.)		(Filing date)	(STATUS-pate	(STATUS-patented, pending, abandoned)		
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I (we) hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and to act in accordance with the instructions from Suda Patent Office:						
Lloyd McA Jules E. G Eugene Le Arthur Dre	oldberg, Donne,	Reg. No. 20,423; Reg. No. 24,408; Reg. No. 35,930; Reg. No. 36,612;	J. Harold Nissen, Gerald H. Kiel, Stephen M. Chin, Samir R. Patel,	Reg. No. 25,116:		
all of Reed Smith	LLP, 599 LE	XINGTON AVENUE, NEW YORK, N	Y 10022 U.S.A.	·		
Address all telephone calls to: Jules E. Goldberg, Esq. at Telephone No. (212) 521-5400						
Address all correspondence to: Jules E. Goldberg, Esq.  Reed Smith LLP  599 LEXINGTON AVENUE, NEW YORK, N.Y 10022 U.S.A.						
I (we) hereby declare that all statements made herein of my (our) own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.						
Full name of sole or 1st inventor (given name, family name):  Syouji Nogami						
Residence:	Tokyo, Japan		Citizenship:	Japan		
Post Office c/o SUMCO CORPORATION, 2-1, Shibaura 1-chome, Minato-ku, Tokyo Japan						
Inventor's signature: Syoup Mogon Date: 13/01/06						
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Docket No.: JG-SU-5224/500577.20013

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Full name of 2nd in	ventor (given name, family name):	Yukichi Horioka				
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Inventor's signature:						

Docket No.: JG-SU-5223/500577.20013

page 4

Full name of 3rd in	ventor (given name, family name):	Shoichi Yamauchi		
Residence:	Tokyo, Japan	Citizenship:	Japan	
Post Office Address:	c/o DENSO CORPORATION, 1-1, Showa-cho, Kariya-shi, Aichi Japan			
Inventor's signature: Shork Jamanah, Date: Jamuary 12, 2006				